2SK359

Silicon N-Channel MOS FET

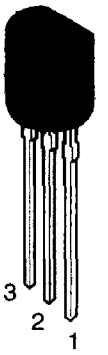
HITACHI

Application

VHF amplifier

Outline

TO-92 (2)



1. Gate
2. Source
3. Drain

Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	V_{DSX} *1	20	V
Gate to source voltage	V_{GSS}	±5	V
Drain current	I_D	30	mA
Gate current	I_G	±1	mA
Channel power dissipation	Pch	400	mW
Channel temperature	Tch	150	°C
Storage temperature	Tstg	−55 to +150	°C

Note: 1. V_{GS} = −4 V

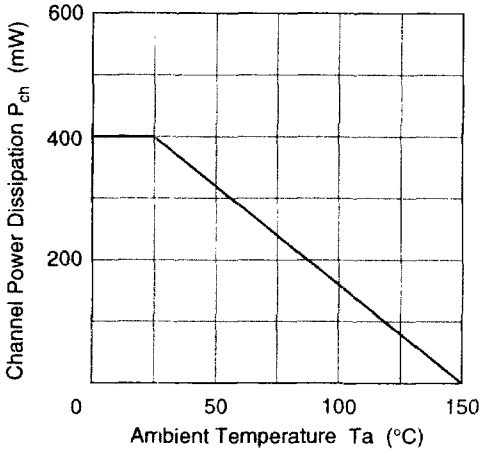
Electrical Characteristics (Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{(BR)DSX}$	20	—	—	V	I_D = 100 µA, V_{GS} = −4 V
Gate cutoff current	I_{GSS}	—	—	±20	nA	V_{GS} = ±5 V, V_{DS} = 0
Drain current	I_{DSS} *1	4	—	12	mA	V_{DS} = 10 V, V_{GS} = 0
Gate to source cutoff voltage	$V_{GS(off)}$	0	—	−2.0	V	V_{DS} = 10 V, I_D = 10 µA
Forward transfer admittance	$\|y_{fs}\|$	8	14	—	mS	V_{DS} = 10 V, V_{GS} = 0, f = 1 kHz
Input capacitance	Ciss	—	2.5	—	pF	V_{DS} = 10 V, V_{GS} = 0, f = 1 MHz
Output capacitance	Coss	—	1.6	—	pF	
Reverse transfer capacitance	Crss	—	0.03	—	pF	
Power gain	PG	—	30	—	dB	V_{DS} = 10 V, V_{GS} = 0, f = 100 MHz
Noise figure	NF	—	2	—	dB	

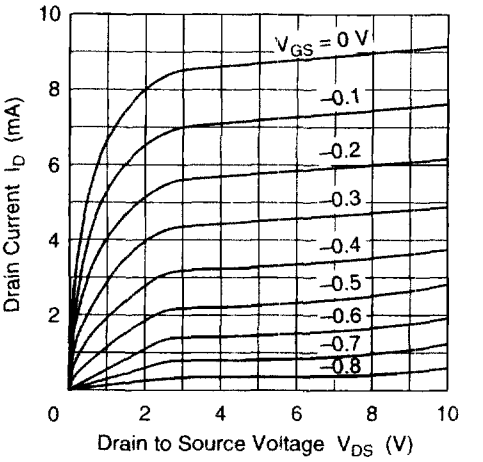
Note: 1. The 2SK359 is grouped by I_{DSS} as follows.

D	E	F
4 to 8	6 to 10	8 to 12

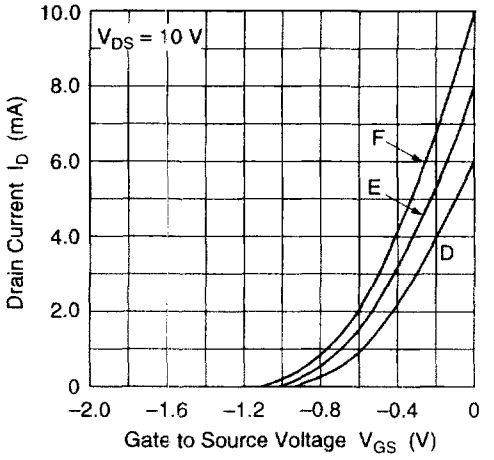
Maximum Channel Dissipation Curve



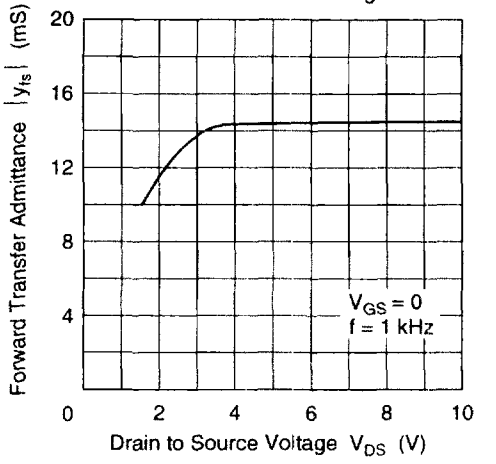
Typical Output Characteristics



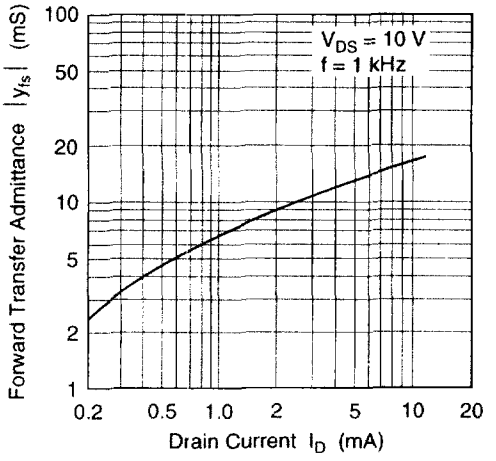
Typical Transfer Characteristics



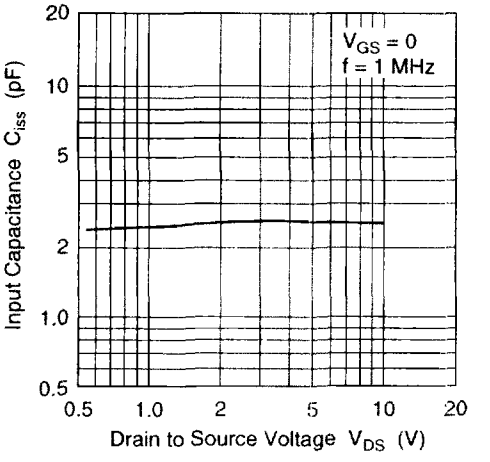
Forward Transfer Admittance vs. Drain to Source Voltage



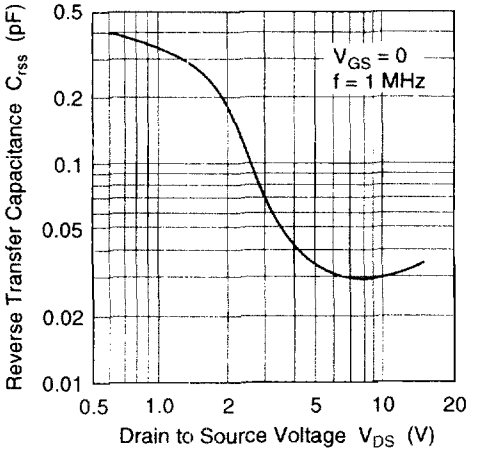
Forward Transfer Admittance vs. Drain Current



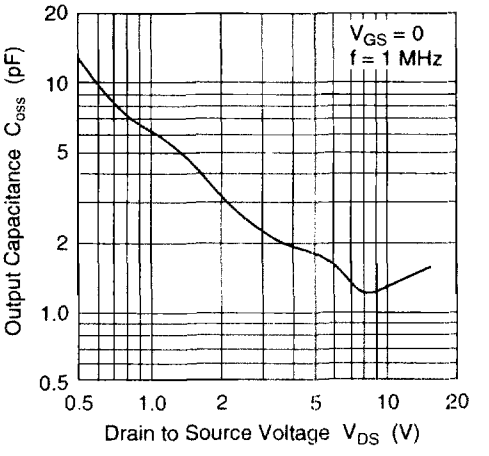
Input Capacitance vs. Drain to Source Voltage



Reverse Transfer Capacitance vs. Drain to Source Voltage



Output Capacitance vs. Drain to Source Voltage



Power Gain, Noise Figure vs.
Drain to Source Voltage